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Atty. Docket No. AMAT/5908/CPI/AL/WIRE/PJ&

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application
Assistant Commissioner of Patents and Trademarks
Washington, D.C. 20231

Re:

Inventor(s):

HOUGONG WANG; KENNY KING-TAI NGAN and ZHENG XU

Title:

SEMICONDUCTOR WAFER PREHEATING

Transmitted herewith is the patent application identified above, including:

- X Specification, claims and abstract, totaling <u>27</u> pages.
- X Drawings totaling <u>5</u> pages, X Formal ___ Informal.
- X Executed Declaration and Power of Attorney.
 - _ Information Disclosure Statement w/ Form 1449 and References.
- X Assignment of the invention to **Applied Materials, Inc.**

X Assignment Recordation Cover Sheet

Assignment necordation cover sheet					
FEE CALCULATION					
Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	64	-20=	44	x \$18.00	\$792.00
Independent Claims	4	-3=	1	x \$84.00	\$ 84.00
Basic Filing Fee \$740.00					\$ 740.00
TOTAL FEES					\$1,616.00

- X The Commissioner is hereby authorized to charge \$1,616.00 to Deposit Account No. 50-1074/5908/CPI/AL WIRE/PJS.
- <u>X</u> The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. <u>50-1074/5908/CPI/AL WIRE/PJS</u>. A duplicate copy of this transmittal is enclosed.
- X Please address all future correspondence to:

PATENT COUNSEL
APPLIED MATERIALS, INC.
Legal Affairs Department

P.O.BOX 450A

Santa Clara, CA. 95052

I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in

Express Mail Receipt No. EL849164562US

1-14-02

Signature Sell Mulley

Respectfully submitted,

Robert W. Mulcahy// Registration No. 25/436

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